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Application ID: 09681712
Title of Invention: METAL PLATING APPARATUS AND
PROCESS
First Named Inventor: Johji Nakamoto
Domestic/Foreign Application: Domestic Application
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Deposit Account Name: Robert A. Walsh



TRANSMITTAL FORM



Electronic Version 1.0.2

Stylesheet Version: 1.0

METAL PLATING APPARATUS AND PROCESS

First Named Inventor: Mr. Johji Nakamoto

SUBMITTED BY

Name: Mr. Robert A. Walsh Esq.

Registration Number: 26,516

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Date Signed: 20010524

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Attached Files:

fee-transmittal	JP9-1999-0277-US1fee.xml
bibd-transmittal	JP9-1999-0277-US1apds.xml
patent-assignment	JP9-1999-0277-US1asgn.xml
specification	JP919990277US1.xml
declaration	JP919990277US1dec1.tif

declaration

JP919990277US1dec2.tif

Attached Image File(s):

JP919990277US1dec1.tif

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Comments:

ASSIGNEE: International Business Machines Corporation ASSIGNEE ADDRESS:Armonk, NY

IBM
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Declaration and Power of Attorney for Patent Application

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name; I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled: METAL PLATING APPARATUS AND PROCESS

the specification of which (check one)

☒ is attached hereto.

☐ was filed on _____ as Application Serial No. _____ and was amended on _____.

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to the patentability of this application in accordance with Title 37, Code of Federal Regulations, §1.56.

I hereby claim foreign priority benefits under Title 35, United States Code, §119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

Prior Foreign Application(s):

Number	Country	Day/Month/Year	Priority Claimed
2000-152494	Japan	24/05/2000	Yes

I hereby claim the benefit under Title 35, United States Code, §120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, §112, I acknowledge the duty to disclose information material to the patentability of this application as defined in Title 37, Code of Federal Regulations, §1.56 which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

Prior U.S. Applications:

Serial No.	Filing Date	Status
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I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

As a named inventor, I hereby appoint the following attorneys and/or agents to prosecute this application and transact all business in the Patent and Trademark Office connected therewith: Mark F. Chadurjian, Reg. No. 30,739; Richard A. Henkler, Reg. No. 39,220; Richard M. Kotulak, Reg. No. 27,712; James M. Leas, Reg. No. 34,372; William D. Sabo, Reg. No. 27,485; Eugene I. Shkurko, Reg. No. 38,678; Robert A. Walsh, Reg. No. 28,518; Howard J. Walter, Jr., Reg. No. 24,832; Christopher A. Hughes, Reg. No.

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FEE TRANSMITTAL

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Patent fees are subject to annual revisions on or about October 1st of each year.

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TOTAL FEES AUTHORIZED: \$ 1 002

The commissioner is hereby authorized to charge indicated processing and/or publication fees and credit any overpayments to:

Deposit Account Number: 09-0456



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Charge Any Additional Fee Required Under 37 C.F.R. Sections 1.16 and 1.17.

SUBMITTED BY

Authorized Name: Robert A. Walsh

Electronic Signature Mark: Robert A. Walsh /s/

Date Signed: 20010521

BASIC FILING FEE

Fee Description	Fee Code	Fee Paid
Utility Filing Fee	101	\$ 710

Subtotal For Basic Filing Fee: \$ 710

EXTRA CLAIM FEES

	Fee Code	Fee	Extra Claims	Fee Paid
Total Claims: 34	103	\$ 18	14	\$ 252
Independent Claims: 3	102	\$ 80	0	\$ 0

Subtotal For Extra Claims Fees: \$ 252

[illegible]Subtotal For Additional Fees: \$ 40